### **DNR-MIL-4**

# 4-Slot, Military-Grade I/O Chassis







- Military/Rugged 38999 connectivity
- 100% COTS solution
- Supported by over 90 standard DNR-series I/O boards
- 5g vibration, 100g shock, sealed to IP66
- Dual GigE ports (control and diagnostic)
- Designed for MIL-STD-461/810/1275 compliance
- TSN Deterministic Ethernet
- PowerDNA, UEIPAC, UEIMODBUS, UEISIM and UEIOPCUA configurations
- No rotary cooling devices
- Extensive software support including Windows, Linux, VxWorks, QNX, RTX and more
- Fully compatible with UEI's new Cyber Security products



The DNR-MIL-4 is the latest deployment of UEI's popular RACKtangle® architecture. Based on UEI's popular DNR-MIL, it offers slots for four I/O boards. Designed for use in the toughest environments, the DNR-MIL-4 is ideal for military ground vehicle and aerospace deployments, as well as a huge assortment of commercial applications. All connectivity is through ROHS compliant 38999 connectors.

The DNR-MIL-4 is available with UEI's three primary CPU options—the 8347 PowerPC, the Arm-based SoloX, and the quad-core Zynq UltraScale. For use in PowerDNA/slaved mode, the 8347 version is recommended. For embedded applications, the SoloX or Zynq may be preferred, depending on the specifics of the application. The SoloX and Zynq CPU series also support TSN Ethernet timing protocols. Please see the UEIPAC datasheet for specifics on the various CPUs.

Electronically, the DNR-MIL-4 is identical to the standard DNR Series RACKtangle, except for hold-up and protection circuitry on the power supply inputs to meet MIL-STD-1275/704. This means the DNR-MIL-4 uses standard DNR-series boards (e.g., DNR-AI-217 or DNR-1553-553). With over 90 unique I/O boards and 4 slots available, there's sure to be a configuration matching your application.

The new DNR-MIL-4 is designed to meet the most commonly required elements of MIL-STD-461 and -810, and is sealed to at least IP66/NEMA6 standards. All this is housed in a compact 9.5" W x 7.1" D x 4.3" H chassis, weighing less than 10 pounds and typically consuming less than 30 W. Heat transfer from the internal electronics to the external chassis is designed such that no fans or rotary cooling is required. All internal printed circuit boards are conformal coated to ensure the highest reliability.

The DNR-MIL-4 is available in different deployment options, including: PowerDNA, UEIPAC, UEIMODBUS, UEISIM and UEIOPCUA.

### PowerDNA: DNR-MIL-4

In PowerDNA mode, the RACKtangle operates as a slave I/O device, running under the control of a host PC. All application code in this mode is created and run on the host. PowerDNR mode offers almost unprecedented software support, including:

- All popular operating systems, including Windows, Linux, VxWorks, QNX, RTX and InTime
- All popular programming languages, including: C, C++, Python and JAVA



The new DNR-MIL-4 provides 4 I/O slots and uses standard DNR-series I/O boards (e.g., DNR-AI-217). It is available in the standard PowerDNR configuration or as a UEIPAC, UEISIM, or UEIOPC.

 All popular application packages, including MATLAB, Simulink, LabVIEW, and more

### **UEIPAC 400R-MIL**

When deployed as a UEIPAC, the standard firmware running on a RACKtangle is replaced by either a Linux or VxWorks operating system. The user then writes the Linux/VxWorks application that runs on the DNR-MIL-4. In this mode, the DNR-MIL-4 can run fully standalone, or may be linked to a host via the Ethernet, 1553, serial, or any method you can program.

### **UEISIM 400R-MIL**

Simulink users will appreciate the ability to build models in Simulink, compile them in Embedded Coder and then deploy them on the UEISIM hardware. It's an ideal platform for testing models on actual hardware. Once the model is proven, it can be deployed using the exact same hardware.

### **UEIMODBUS 400R-MIL**

Users needing a compact, rugged Modbus TCP I/O slave will appreciate UEIMODBUS. The rugged, IP66/NEMA6 sealed DNR-MIL-4 allows you to deploy your I/O system in the field, without any additional enclosure and protection.

### **UEIOPCUA 400R-MIL**

The rugged UEIOPC 400R-MIL acts as a standalone OPC-UA server (not dependent on Windows), supporting the OPC-UA Historian functionality. System configuration is made easy by an intuitive, easy-to-use web/HTML interface.

The DNR-MIL-4 platform is 100% COTS, and supported by UEI's family of over 90 compatible analog, digital and interface I/O boards, including analog inputs up to 24-bits, thermocouples, RTDs, ICP/IEPE, ARINC-429/453/708, MIL-STD-1553, CAN, RVDT/LVDT, synchro/resolver, RS-232/422/485, strain gauge, quadrature encoder, high-voltage analog outputs (up to 115 VDC) with high drive analog output (up to 200 mA), function generator outputs and more.

Whether your application is on a ship or boat, in an aircraft, in a rocket, on an outdoor test cell, on an oil platform or simply going to be left outside and exposed to the elements, the DNR-MIL-4 is an ideal solution. We also have 6 and 12 slot variants.

# **Technical Specifications** DNR-MIL-4 (Power DNA mode)

Primary Ethernet port 10/100/1000Base-T, 38999 connector 10/100/1000Base-T, 38999 connector 10/100/1000Base-T, 38999 connector 10/100/1000Base-T, 38999 connector 20/100/1000Base-T, 38999 connector 20/100/100Base-T, 38999 connector 3999 connector 3999 connector 3999 connector 39999 connector 39990 condendary 39990 connector 39990 con	IL + (I OWEI DIA IIIOGE)	
Diagnostic port  Configuration/serial port  RS-232, 38999 connector  Synchronization options  1. IEEE-1588/PTP 2. DNR-SYNC-1G series cables and board vide both clock and trigger sync signa 3. DNR-IRIG-650 board provides IRIG and time synchronization  I/O Board Support  Series supported  All DNR-series boards  Processor/system  CPU Freescale 8347, 400 MHz, 32-bit  Memory (RAM) 256 MB  Memory (Flash) 32 MB  Host Communications  Distance from host 100 meters max, CAT5/6 cable  Ethernet data transfer rate 20 MB/s  Analog data transfer rate 84 KHz, guaranteed  I/O mode 10 MAP/VMAP real-time 10 My 7.1" D x 4.3" H, 10 lbs. includin 1/O boards  Environmental  Electrical Isolation 350 Vrms  Temperature (operating) -40 °C to 70 °C  Humidity 0 to 95%, non-condensing  Vibration MIL-STD-810 G plus the IEC standards (IEC 60068-2-6) 10 –500 Hz, 5 g, sinusoidal  Shock MIL-STD-810G plus the IEC standards to orientations; 30 g, 11 ms half sine, 18 shocks at 6 orientations; 30 g, 11 ms half sine, 18 shocks at 6 orientations  Altitude 70,000 feet, maximum  EMI / RFI Designed to meet MIL-STD-461  Sealing Default unit sealed to IP 66 or better. Pressure relief valves support continuo altitude changes of 5000 fpm.	er Interface MIL Serie	es Ruggedized Chassis
Configuration/serial port Synchronization options  1. IEEE-1588/PTP 2. DNR-SYNC-1G series cables and board vide both clock and trigger sync signa 3. DNR-IRIG-650 board provides IRIG and time synchronization  I/O Board Support  Series supported All DNR-series boards  Processor/system  CPU Freescale 8347, 400 MHz, 32-bit Memory (RAM) 256 MB Memory (Flash) 32 MB  Memory (Flash) Distance from host Ethernet data transfer rate 20 MB/s  Analog data transfer rate I/O mode Update >1,000 I/O channels at 4 kHz, guaranteed  Physical Dimensions / Weight 4 I/O slots 9.5" W x 7.1" D x 4.3" H, 10 lbs. includin I/O boards  Environmental Electrical Isolation Temperature (operating) Temperature (storage) Humidity  Vibration MIL-STD-810 G plus the IEC standards of orientations; 30 g, 11 ms half sine, 18 shocks at 6 orientations; 30 g, 11 ms half sine, 18 shocks at 6 orientations  Altitude EMI / RFI Designed to meet MIL-STD-461 Sealing Default unit sealed to IP 66 or better. Pressure relief valves support continuo altitude changes of 5000 fpm.	thernet port 10/100/1000Bas	se-T, 38999 connector
1. IEEE-1588/PTP 2. DNR-SYNC-1G series cables and board vide both clock and trigger sync signa 3. DNR-IRIG-650 board provides IRIG and time synchronization  I/O Board Support  Series supported All DNR-series boards  Processor/system  CPU Freescale 8347, 400 MHz, 32-bit Memory (RAM) 256 MB  Memory (Flash) 32 MB  Host Communications  Distance from host 100 meters max, CAT5/6 cable Ethernet data transfer rate 20 MB/s  Analog data transfer rate 20 MB/s  Analog data transfer rate Update >1,000 I/O channels at 4 kHz, guaranteed  Physical Dimensions / Weight 4 I/O slots 9.5" W x 7.1" D x 4.3" H, 10 lbs. includin I/O boards  Environmental  Electrical Isolation 350 Vrms  Temperature (operating) -40 °C to 70 °C  Temperature (storage) -40 °C to 70 °C  Humidity 0 to 95%, non-condensing  Vibration MIL-STD-810 G plus the IEC standards (IEC 60068-2-6) 10–500 Hz, 5 g, sinusoidal  Shock MIL-STD-810 G plus the IEC standards (IEC 60068-2-27) 100 g, 3 ms half sine, 18 shocks at 6 orientations; 30 g, 11 ms half sine, 18 shocks at 6 orientations; 30 g, 11 ms half sine, 18 shocks at 6 orientations  Altitude 70,000 feet, maximum  Default unit sealed to IP 66 or better. Pressure relief valves support continuo altitude changes of 5000 fpm.	ic port 10/100/1000Bas	se-T, 38999 connector
2. DNR-SYNC-1G series cables and board vide both clock and trigger sync signa 3. DNR-IRIG-650 board provides IRIG and time synchronization  I/O Board Support  Series supported All DNR-series boards  Processor/system  CPU Freescale 8347, 400 MHz, 32-bit  Memory (RAM) 256 MB  Memory (Flash) 32 MB  Host Communications  Distance from host 100 meters max, CAT5/6 cable Ethernet data transfer rate 20 MB/s  Analog data transfer rate 4 ACK tangle configuration  DMAP/VMAP real-time 1/O mode 1/O boards  Physical Dimensions / Weight 4 I/O slots 9.5" W x 7.1" D x 4.3" H, 10 lbs. includin 1/O boards  Environmental Electrical Isolation 350 Vrms  Temperature (operating) -40 °C to 70 °C  Temperature (storage) -40 °C to 70 °C  Humidity 0 to 95%, non-condensing  Vibration MIL-STD-810 G plus the IEC standards (IEC 60068-2-64) 10-500 Hz, 5 g, sinusoidal Shock MIL-STD-810G plus the IEC standards to orientations; 30 g, 11 ms half sine, 18 shocks at 6 orientations; 30 g, 11 ms half sine, 18 shocks at 6 orientations; 30 g, 11 ms half sine, 18 shocks at 6 orientations  Altitude 70,000 feet, maximum Designed to meet MIL-STD-461  Sealing Default unit sealed to IP 66 or better. Pressure relief valves support continuo altitude changes of 5000 fpm.	ation/serial port RS-232, 38999 c	connector
vide both clock and trigger sync signa 3. DNR-IRIG-650 board provides IRIG and time synchronization  I/O Board Support  Series supported All DNR-series boards  Processor/system  CPU Freescale 8347, 400 MHz, 32-bit  Memory (RAM) 256 MB  Memory (Flash) 32 MB  Host Communications  Distance from host 100 meters max, CAT5/6 cable  Ethernet data transfer rate 20 MB/s  Analog data transfer rate 84 KB, 2 Capable of sustained transfer RACKtangle configuration  DMAP/VMAP real-time 1/O mode 1/O boards  Physical Dimensions / Weight  4 1/O slots 9.5" W x 7.1" D x 4.3" H, 10 lbs. including 1/O boards  Environmental  Electrical Isolation 350 Vrms  Temperature (operating) -40 °C to 70 °C  Temperature (storage) -40 °C to 70 °C  Humidity 0 to 95%, non-condensing  Vibration MIL-STD-810 G plus the IEC standards of 10-500 Hz, 5 g, sinusoidal  Shock MIL-STD-810G plus the IEC standards of 10-500 Hz, 5 g, sinusoidal  Altitude 70,000 feet, maximum  EMI / RFI Designed to meet MIL-STD-461  Sealing Default unit sealed to IP 66 or better. Pressure relief valves support continuo altitude changes of 5000 fpm.	ization options 1. IEEE-1588/PTF	
3. DNR-IRIG-650 board provides IRIG and time synchronization  I/O Board Support  Series supported  Processor/system  CPU Freescale 8347, 400 MHz, 32-bit  Memory (RAM) 256 MB  Memory (Flash) 32 MB  Host Communications Distance from host 100 meters max, CAT5/6 cable  Ethernet data transfer rate 20 MB/s  Analog data transfer rate 44 Ly MB/s  Analog data transfer rate 56 MS/s. Capable of sustained transfer RACKtangle configuration  DMAP/VMAP real-time 1/O mode 14 kHz, guaranteed  Physical Dimensions / Weight 41/O slots 9.5" W x 7.1" D x 4.3" H, 10 lbs. includin 1/O boards  Environmental  Electrical Isolation 350 Vrms  Temperature (operating) -40 °C to 70 °C  Humidity 0 to 95%, non-condensing  Vibration MIL-STD-810 G plus the IEC standards (IEC 60068-2-64) 10-500 Hz, 5 g (rms), broadband randor (IEC 60068-2-6) 10-500 Hz, 5 g, sinusoidal  Shock MIL-STD-810G plus the IEC standards be orientations; 30 g, 11 ms half sine, 18 shocks at 6 orientations; 30 g, 11 ms half sine, 18 shocks at 6 orientations; 30 g, 11 ms half sine, 18 shocks at 6 orientations; 30 g, 11 ms half sine, 18 shocks at 6 orientations  Altitude 70,000 feet, maximum  Designed to meet MIL-STD-461  Sealing Default unit sealed to IP 66 or better. Pressure relief valves support continuo altitude changes of 5000 fpm.		
I/O Board Support  Series supported All DNR-series boards  Processor/system  CPU Freescale 8347, 400 MHz, 32-bit  Memory (RAM) 256 MB  Memory (Flash) 32 MB  Host Communications  Distance from host 100 meters max, CAT5/6 cable  Ethernet data transfer rate 20 MB/s  Analog data transfer rate 84 KKangle configuration  DMAP/VMAP real-time 1/O mode 1/O channels at 4 kHz, guaranteed  Physical Dimensions / Weight  4 I/O slots 9.5" W x 7.1" D x 4.3" H, 10 lbs. includin 1/O boards  Environmental  Electrical Isolation 350 Vrms  Temperature (operating) -40 °C to 70 °C  Temperature (storage) -40 °C to 70 °C  Humidity 0 to 95%, non-condensing  Vibration MIL-STD-810 G plus the IEC standards (IEC 60068-2-6) 10-500 Hz, 5 g, sinusoidal  Shock MIL-STD-810G plus the IEC standards & Gorientations; 30 g, 11 ms half sine, 18 shocks at 6 orientations; 30 g, 11 ms half sine, 18 shocks at 6 orientations; 30 g, 11 ms half sine, 18 shocks at 6 orientations  Altitude 70,000 feet, maximum  EMI / RFI Designed to meet MIL-STD-461  Sealing Default unit sealed to IP 66 or better. Pressure relief valves support continuo altitude changes of 5000 fpm.		
I/O Board Support  Series supported All DNR-series boards  Processor/system  CPU Freescale 8347, 400 MHz, 32-bit  Memory (RAM) 256 MB  Memory (Flash) 32 MB  Host Communications Distance from host 100 meters max, CAT5/6 cable  Ethernet data transfer rate 20 MB/s  Analog data transfer rate 4		•
Series supported Processor/system CPU Freescale 8347, 400 MHz, 32-bit Memory (RAM) 256 MB Memory (Flash) 32 MB  Host Communications Distance from host 100 meters max, CAT5/6 cable Ethernet data transfer rate 20 MB/s Analog data transfer rate 84 KKtangle configuration  DMAP/VMAP real-time 86 I/O mode 1/O channels at 4 kHz, guaranteed  Physical Dimensions / Weight 4 I/O slots 9.5" W x 7.1" D x 4.3" H, 10 lbs. including I/O boards  Environmental Electrical Isolation 350 Vrms Temperature (operating) -40 °C to 70 °C Temperature (storage) -40 °C to 70 °C Temperature (storage) -40 °C to 70 °C Humidity 0 to 95%, non-condensing  Vibration MIL-STD-810 G plus the IEC standards of 10–500 Hz, 5 g, sinusoidal  Shock MIL-STD-810G plus the IEC standards of 10–500 Hz, 5 g, sinusoidal  Shock MIL-STD-810G plus the IEC standards of 10–500 Hz, 5 g, sinusoidal  Shock MIL-STD-810G plus the IEC standards of 10–500 Hz, 5 g, sinusoidal  Altitude 70,000 feet, maximum  EMI / RFI Designed to meet MIL-STD-461  Sealing Default unit sealed to IP 66 or better. Pressure relief valves support continuo altitude changes of 5000 fpm.	time synchron	IZALION
Series supported Processor/system CPU Freescale 8347, 400 MHz, 32-bit Memory (RAM) 256 MB Memory (Flash) 32 MB  Host Communications Distance from host 100 meters max, CAT5/6 cable Ethernet data transfer rate 20 MB/s Analog data transfer rate 84 KKtangle configuration  DMAP/VMAP real-time 86 I/O mode 1/O channels at 4 kHz, guaranteed  Physical Dimensions / Weight 4 I/O slots 9.5" W x 7.1" D x 4.3" H, 10 lbs. including I/O boards  Environmental Electrical Isolation 350 Vrms Temperature (operating) -40 °C to 70 °C Temperature (storage) -40 °C to 70 °C Temperature (storage) -40 °C to 70 °C Humidity 0 to 95%, non-condensing  Vibration MIL-STD-810 G plus the IEC standards of 10–500 Hz, 5 g, sinusoidal  Shock MIL-STD-810G plus the IEC standards of 10–500 Hz, 5 g, sinusoidal  Shock MIL-STD-810G plus the IEC standards of 10–500 Hz, 5 g, sinusoidal  Shock MIL-STD-810G plus the IEC standards of 10–500 Hz, 5 g, sinusoidal  Altitude 70,000 feet, maximum  EMI / RFI Designed to meet MIL-STD-461  Sealing Default unit sealed to IP 66 or better. Pressure relief valves support continuo altitude changes of 5000 fpm.	10	
Processor/system  CPU Freescale 8347, 400 MHz, 32-bit  Memory (RAM) 256 MB  Memory (Flash) 32 MB  Host Communications  Distance from host 100 meters max, CAT5/6 cable  Ethernet data transfer rate 20 MB/s  Analog data transfer rate 84 KHz, guaranteed  Physical Dimensions / Weight  4 I/O slots 9.5" W x 7.1" D x 4.3" H, 10 lbs. including I/O boards  Environmental  Electrical Isolation 350 Vrms  Temperature (operating) -40 °C to 70 °C  Temperature (storage) -40 °C to 70 °C  Humidity 0 to 95%, non-condensing  Vibration MIL-STD-810 G plus the IEC standards of the IEC standard		
CPU Freescale 8347, 400 MHz, 32-bit  Memory (RAM) 256 MB  Memory (Flash) 32 MB  Host Communications  Distance from host 100 meters max, CAT5/6 cable  Ethernet data transfer rate 20 MB/s  Analog data transfer rate 8/6 MS/s. Capable of sustained transfer RACKtangle configuration  DMAP/VMAP real-time 1/0 mode 1/0 boards  Environmental 1/0 boards  Environmental 1/0 boards  Environmental 2/1 Electrical Isolation 350 Vrms  Temperature (operating) -40 °C to 70 °C  Temperature (storage) -40 °C to 70 °C  Temperature (storage) -40 °C to 70 °C  Humidity 0 to 95%, non-condensing  Vibration MIL-STD-810 G plus the IEC standards (IEC 60068-2-64) 10-500 Hz, 5 g (rms), broadband rando (IEC 60068-2-6) 10-500 Hz, 5 g, sinusoidal  Shock MIL-STD-810G plus the IEC standards be orientations; 30 g, 11 ms half sine, 18 shocks at 6 orientations; 30 g, 11 ms half sine, 18 shocks at 6 orientations  Altitude 70,000 feet, maximum  EMI / RFI Designed to meet MIL-STD-461  Sealing Default unit sealed to IP 66 or better. Pressure relief valves support continuo altitude changes of 5000 fpm.		ooards
Memory (RAM)  Memory (Flash)  Memory (Flash)  Memory (Flash)  Distance from host  Ethernet data transfer rate  Analog data transfer rate  DMAP/VMAP real-time I/O mode  Physical Dimensions / Weight  4 I/O slots  Environmental  Electrical Isolation  Temperature (operating)  Temperature (storage)  Humidity  Vibration  (IEC 60068-2-64)  (IEC 60068-2-6)  Shock  MIL-STD-810 G plus the IEC standards in Inchesions; 30 g, 11 ms half sine, 18 shocks at 6 orientations; 30 g, 11 ms half sine, 18 shocks at 6 orientations  Altitude  Temperature (soe or the sine)  Altitude  To your feet or the sine in the shocks at 6 orientations; 30 g, 11 ms half sine, 18 shocks at 6 orientations  Altitude  Temperature (soe or the sine)  Altitude  To your feet, maximum  Default unit sealed to IP 66 or better. Pressure relief valves support continuo altitude changes of 5000 fpm.		400 MH 22 L'
Memory (Flash)  Host Communications  Distance from host  Ethernet data transfer rate  Analog data transfer rate  DMAP/VMAP real-time I/O mode  Physical Dimensions / Weight  4 I/O slots  Environmental  Electrical Isolation  Temperature (operating)  Temperature (storage)  Humidity  Vibration  (IEC 60068-2-64)  (IEC 60068-2-64)  (IEC 60068-2-27)  Altitude  Altitude  MIL-STD-810 G plus the IEC standards to orientations; 30 g, 11 ms half sine, 18 shocks at 6 orientations  Altitude  Temperature (altitude changes of 5000 fpm.  Power Requirements		400 MHz, 32-bit
Host Communications  Distance from host  Ethernet data transfer rate  Analog data transfer rate  DMAP/VMAP real-time I/O mode  Physical Dimensions / Weight  4 I/O slots  Environmental  Electrical Isolation  Temperature (operating)  Vibration  (IEC 60068-2-64) (IEC 60068-2-64) (IEC 60068-2-27)  Altitude  Altitude  Altitude  EMI / RFI  Designed to meet MIL-STD-461  Sealing  Power Requirements  100 meters max, CAT5/6 cable  20 MB/s  Analog data transfer rate  20 MB/s  4 kHz, guaranteed  21 A kHz, guaranteed  22 MB/s  4 A kHz, guaranteed  24 C to 70 °C  25 To 70 °C  26 To 70 °C  27 O °C  40 °C to 70 °C  4	(RAM) 256 MB	
Distance from host  Ethernet data transfer rate  Analog data transfer rate  Analog data transfer rate  DMAP/VMAP real-time I/O mode  Physical Dimensions / Weight  4 I/O slots  Physical Isolation  Environmental  Electrical Isolation  Temperature (operating)  Temperature (storage)  Humidity  Vibration  (IEC 60068-2-64)  (IEC 60068-2-6)  Shock  (IEC 60068-2-27)  Altitude  Altitude  Altitude  Power Requirements  20 MB/s  20 MB		
Ethernet data transfer rate  Analog data transfer  Analog data transfe		
Analog data transfer rate  >6 MS/s. Capable of sustained transfer RACKtangle configuration  DMAP/VMAP real-time I/O mode  Physical Dimensions / Weight  4 I/O slots  9.5" W x 7.1" D x 4.3" H, 10 lbs. including I/O boards  Environmental  Electrical Isolation  350 Vrms  Temperature (operating)  -40 °C to 70 °C  Temperature (storage)  -40 °C to 70 °C  Humidity  0 to 95%, non-condensing  Vibration  MIL-STD-810 G plus the IEC standards of I/EC 60068-2-64)  (IEC 60068-2-6)  10-500 Hz, 5 g, sinusoidal  Shock  MIL-STD-810G plus the IEC standards of Orientations;  30 g, 3 ms half sine, 18 shocks at 6 orientations;  30 g, 11 ms half sine, 18 shocks at 6 orientations  Altitude  70,000 feet, maximum  EMI / RFI  Designed to meet MIL-STD-461  Sealing  Power Requirements		c, CAT5/6 cable
RACKtangle configuration  DMAP/VMAP real-time I/O mode		
DMAP/VMAP real-time I/O mode I		•
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I/O mode	AAD roal time	I/O channals
Physical Dimensions / Weight  4 I/O slots  9.5" W x 7.1" D x 4.3" H, 10 lbs. including I/O boards  Environmental  Electrical Isolation  350 Vrms  Temperature (operating)  -40 °C to 70 °C  Temperature (storage)  -40 °C to 70 °C  Humidity  0 to 95%, non-condensing  Vibration  MIL-STD-810 G plus the IEC standards (IEC 60068-2-64)  (IEC 60068-2-6)  10-500 Hz, 5 g, rms, broadband randor (IEC 60068-2-6)  Shock  MIL-STD-810G plus the IEC standards to 10 g, 3 ms half sine, 18 shocks at 6 orientations; 30 g, 11 ms half sine, 18 shocks at 6 orientations  Altitude  70,000 feet, maximum  EMI / RFI  Designed to meet MIL-STD-461  Sealing  Default unit sealed to IP 66 or better. Pressure relief valves support continuogaltitude changes of 5000 fpm.		
4 I/O slots  9.5" W x 7.1" D x 4.3" H, 10 lbs. including I/O boards  Environmental  Electrical Isolation  350 Vrms  Temperature (operating)  -40 °C to 70 °C  Temperature (storage)  -40 °C to 70 °C  Humidity  0 to 95%, non-condensing  Vibration  (IEC 60068-2-64)  10-500 Hz, 5 g (rms), broadband randout (IEC 60068-2-64)  10-500 Hz, 5 g, sinusoidal  Shock  MIL-STD-810G plus the IEC standards & MIL-STD-810G plus the IEC standards & Government of th	, , ,	
Environmental  Electrical Isolation 350 Vrms  Temperature (operating) -40 °C to 70 °C  Temperature (storage) -40 °C to 70 °C  Humidity 0 to 95%, non-condensing  Vibration MIL-STD-810 G plus the IEC standards (IEC 60068-2-64) 10–500 Hz, 5 g, sinusoidal  Shock MIL-STD-810G plus the IEC standards & MIL-STD-810G plus the IEC standards & Gorientations, 30 g, 11 ms half sine, 18 shocks at 6 orientations  Altitude 70,000 feet, maximum  EMI / RFI Designed to meet MIL-STD-461  Sealing Default unit sealed to IP 66 or better. Pressure relief valves support continuo altitude changes of 5000 fpm.		4 3" H 10 lbs including
Electrical Isolation  Temperature (operating)  Temperature (storage)  Humidity  O to 95%, non-condensing  Vibration  (IEC 60068-2-64)  (IEC 60068-2-6)  Shock  (IEC 60068-2-27)  MIL-STD-810 G plus the IEC standards of orientations; 30 g, 11 ms half sine, 18 shocks at 6 orientations  Altitude  To,000 feet, maximum  EMI / RFI  Designed to meet MIL-STD-461  Sealing  Power Requirements		14.5 11, 10 lb3. Including
Electrical Isolation  Temperature (operating)  Temperature (storage)  Humidity  O to 95%, non-condensing  Vibration  (IEC 60068-2-64)  (IEC 60068-2-6)  Shock  (IEC 60068-2-27)  MIL-STD-810 G plus the IEC standards of orientations; 30 g, 11 ms half sine, 18 shocks at 6 orientations  Altitude  To,000 feet, maximum  EMI / RFI  Designed to meet MIL-STD-461  Sealing  Power Requirements	nental	
Temperature (storage)  -40 °C to 70 °C  Humidity  0 to 95%, non-condensing  Wibration  MIL-STD-810 G plus the IEC standards  (IEC 60068-2-64)  10–500 Hz, 5 g (rms), broadband rando  (IEC 60068-2-6)  Shock  MIL-STD-810G plus the IEC standards to 100 g, 3 ms half sine, 18 shocks at 6 orientations;  30 g, 11 ms half sine, 18 shocks at 6 orientations  Altitude  To,000 feet, maximum  EMI / RFI  Designed to meet MIL-STD-461  Sealing  Default unit sealed to IP 66 or better. Pressure relief valves support continuo altitude changes of 5000 fpm.	Isolation 350 Vrms	
Temperature (storage)  -40 °C to 70 °C  Humidity  0 to 95%, non-condensing  Wibration  MIL-STD-810 G plus the IEC standards  (IEC 60068-2-64)  10–500 Hz, 5 g (rms), broadband rando  (IEC 60068-2-6)  Shock  MIL-STD-810G plus the IEC standards to 100 g, 3 ms half sine, 18 shocks at 6 orientations;  30 g, 11 ms half sine, 18 shocks at 6 orientations  Altitude  To,000 feet, maximum  EMI / RFI  Designed to meet MIL-STD-461  Sealing  Default unit sealed to IP 66 or better. Pressure relief valves support continuo altitude changes of 5000 fpm.	cure (operating) -40 °C to 70 °C	
Humidity 0 to 95%, non-condensing  Vibration MIL-STD-810 G plus the IEC standards (IEC 60068-2-64) 10–500 Hz, 5 g (rms), broadband rando (IEC 60068-2-6) 10–500 Hz, 5 g, sinusoidal  Shock MIL-STD-810G plus the IEC standards to 100 g, 3 ms half sine, 18 shocks at 6 orientations; 30 g, 11 ms half sine, 18 shocks at 6 orientations  Altitude 70,000 feet, maximum  EMI / RFI Designed to meet MIL-STD-461  Sealing Default unit sealed to IP 66 or better. Pressure relief valves support continuo altitude changes of 5000 fpm.		
VibrationMIL-STD-810 G plus the IEC standards(IEC 60068-2-64)10-500 Hz, 5 g (rms), broadband rando(IEC 60068-2-6)10-500 Hz, 5 g, sinusoidalShockMIL-STD-810G plus the IEC standards b(IEC 60068-2-27)100 g, 3 ms half sine, 18 shocks at 6 orientations; 30 g, 11 ms half sine, 18 shocks at 6 orientationsAltitude70,000 feet, maximumEMI / RFIDesigned to meet MIL-STD-461SealingDefault unit sealed to IP 66 or better. Pressure relief valves support continuo altitude changes of 5000 fpm.Power Requirements		ondensina
(IEC 60068-2-64) (IEC 60068-2-6)  Shock  (IEC 60068-2-27)  In the second of the second		•
(IEC 60068-2-6)  Shock  MIL-STD-810G plus the IEC standards by 100 g, 3 ms half sine, 18 shocks at 6 orientations; 30 g, 11 ms half sine, 18 shocks at 6 orientations  Altitude  70,000 feet, maximum  EMI / RFI  Designed to meet MIL-STD-461  Sealing  Default unit sealed to IP 66 or better. Pressure relief valves support continuo altitude changes of 5000 fpm.		•
Shock  (IEC 60068-2-27)  MIL-STD-810G plus the IEC standards to 100 g, 3 ms half sine, 18 shocks at 6 orientations; 30 g, 11 ms half sine, 18 shocks at 6 orientations  Altitude  70,000 feet, maximum  EMI / RFI  Designed to meet MIL-STD-461  Sealing  Default unit sealed to IP 66 or better. Pressure relief valves support continuo altitude changes of 5000 fpm.  Power Requirements		
(IEC 60068-2-27)  100 g, 3 ms half sine, 18 shocks at 6 orientations; 30 g, 11 ms half sine, 18 shocks at 6 orientations  Altitude  70,000 feet, maximum  EMI / RFI  Designed to meet MIL-STD-461  Sealing  Default unit sealed to IP 66 or better. Pressure relief valves support continuo altitude changes of 5000 fpm.  Power Requirements		
6 orientations; 30 g, 11 ms half sine, 18 shocks at 6 orientations  Altitude 70,000 feet, maximum  EMI / RFI Designed to meet MIL-STD-461  Sealing Default unit sealed to IP 66 or better. Pressure relief valves support continuo altitude changes of 5000 fpm.  Power Requirements		
Altitude 70,000 feet, maximum  EMI / RFI Designed to meet MIL-STD-461  Sealing Default unit sealed to IP 66 or better. Pressure relief valves support continuo altitude changes of 5000 fpm.  Power Requirements		sinc, to shocks at
Altitude 70,000 feet, maximum  EMI / RFI Designed to meet MIL-STD-461  Sealing Default unit sealed to IP 66 or better. Pressure relief valves support continuo altitude changes of 5000 fpm.  Power Requirements	3.	sine, 18 shocks at
EMI / RFI Designed to meet MIL-STD-461  Sealing Default unit sealed to IP 66 or better. Pressure relief valves support continuo altitude changes of 5000 fpm.  Power Requirements		vim. um
Sealing  Default unit sealed to IP 66 or better.  Pressure relief valves support continuo altitude changes of 5000 fpm.  Power Requirements		
Pressure relief valves support continuo altitude changes of 5000 fpm.  Power Requirements		
altitude changes of 5000 fpm.  Power Requirements		
· ·		
· ·	equirements	
5 30 VDC (113/220 V/Cadaptor avail		/220 VAC adaptor available)
Power 12 W (not including I/O boards)		•
Power Quality requirement Designed to meet MIL-STD704/1275		
Reliability	, ,	
MTBF 100,000 hours		
100,000 110413	100,000 110013	

### **UEIPAC 400R-MIL**

UEIPAC 400R-MIL	
Computer Interface	MIL Series Ruggedized Chassis
Primary Ethernet port	10/100/1000Base-T, 38999 connector
Diagnostic port*	10/100/1000Base-T, 38999 connector *Alternatively can be teamed/bonded with primary port.
Configuration/serial port	RS-232, 38999 connector
USB port	USB 2.0 fully supported
Synchronization options	<ol> <li>I. IEEE-1588/PTP</li> <li>DNR-SYNC-1G series cables</li> <li>DNR-IRIG-650 board IRIG time sync</li> </ol>
TSN support	
Zynq CPU series	Redundant (FRER)
ARM SoloX CPU series	Supported
8347 CPU series	Not supported
I/O Board Support	
Series supported	All DNR-series boards
Software / Operating System	1: 1 154 0/3// 1 4 :111
Embedded OS	Linux kernel 5.4.x (VxWorks Available)
Real-time support	Linux RT or VxWorks support C/C++, Eclipse IDE support
Development language  Development environments	Linux PC or Cygwin Windows environment
EPICS CAS interface	Yes
SNMP library	Yes
OS royalties	None
Processor/system	
CPU	Freescale 8347, ARM based SoloX or Zynq UltraScale Quad Core
Memory	Options dependent on CPU selection
FLASH memory	Options dependent on CPU selection
Solid state hard drive	Options dependent on CPU selection
USB drive interface	Standard USB 2.0 port
Physical Dimensions / Weight	
4 I/O slots	9.5" W x 7.1" D x 4.3" H, 10 lbs. including I/O boards
Environmental	2504
Electrical isolation	350 Vrms -40 °C to 70 °C
Temperature (operating/storage) Humidity	0 to 95%, non-condensing
Vibration	MIL-STD-810G plus the IEC standards below
(IEC 60068-2-64)	10–500 Hz, 5 g (rms), broadband random
(IEC 60068-2-6)	10–500 Hz, 5 g, sinusoidal
Shock	MIL-STD-810G plus the IEC standards below
(IEC 60068-2-27)	100 g, 3 ms half sine, 18 shocks at 6 orientations; 30 g, 11 ms half sine, 18 shocks at 6 orientations
Altitude	70,000 feet, maximum
EMI / RFI	Designed to meet MIL-STD-461
Sealing	Default unit sealed to IP 66 or better. Pressure relief valves support continuous altitude changes of 5000 fpm.
Power Requirements	
Voltage	9–36 VDC (115/220 VAC adaptor available)
Power	12 Watts (not including I/O boards)
Power quality requirement	Designed to meet MIL-STD-704/1275
Reliability	100 000 hours
MTBF	100,000 hours

<sup>\*</sup>The SSD devices used are not manufactured by UEI. As we do not control the source, we cannot offer our 10-year availability guarantee on these devices.

## Cables, Connectors & screw-terminal panels

#### **Connectors**

All connections to the DNR-MIL-4 are made through standard, COTS, nickel plated 38999 connectors. I/O board connections are made through 128-pin connectors where each I/O board utilizes up to 62 of the 128 pins. The Ethernet, USB, diagnostic serial, sync, and hardware reset connections are via 37-pin connectors. Power supply and an auxiliary synchonization connections are through a 13-pin connector. Optional keying is available on the 128 pin, I/O connectors. For keying, order:

DNA-38999-KEY Clocked/keyed I/O connectors (N, A keys)

#### Cables

Though most customers will design custom cables for their deployed systems, customers working on prototypes and/or those building "one-off" systems may desire the ability to connect to the DNR-MIL-4 using more traditional, commercial connections (e.g. RJ-45 for the Ethernet ports).

For these customers, UEI offers a complete array of cables and screw terminal panels that will provide direct access to all signals routed in and out of the chassis.

### LAN/Power Cables

DNA-CBL-LAN-06 Communications cable

6 foot cable connecting the 37-pin LAN/COM/USB port connector to standard commercial connectors. Ethernet ports come out to RJ-45, the serial port to a DB-9 and the USB ports to standard USB jacks.

DNA-CBL-1315-03 Power supply cable

Connects the 13-pin power/sync connector to a standard female DB-15 connector.

### /O board cables

Each 128 pin I/O 38999 connector provides the I/O connectivity for two I/O slots within the DNR-MIL-4. UEI I/O boards utilize either 37- or 62-pin D connectors and these connectors are mapped as follows.

I/O slots one and three map to pins 65-126 on the 38999 connectors (please see diagram below). I/O slots two and four map to pins 1-62 on the 38999s. Note that the 37-pin based boards simply do not use pins 38-62. For this reason, most applications can standardize on 62-pin cables and screw terminal panels and simply ignore "no connection" pins. The exception to this is the STP boards that have been specifically designed for use with 37-pin boards (e.g. DNA-STP-207TC). For these boards 37-pin are also available. Also, as some I/O slots may not be utilized in a given application, cables with a single 37-pin or 62-pin D connector are also available.

The following cables provide the same I/O connectivity as the standard, commercial DNA-CBL-37S and DNA-CBL-62 series cables.

DNA-CBL-12862-05: 5 ft male 128-pin 38999 to 2x DB-62M

DNA-CBL-12837-05: 5 ft male 128-pin 38999 to 2x DB-37F

DNA-CBL-6237M-05: 5 ft male RoHS 128-pin 38999 to 1x DB-37F

and 1x DB-62M

DNA-CBL-62M-03: 3 ft male 128-pin 38999 to 1x DB-62M DNA-CBL-37M-03: 3 ft male 128-pin 38999 to 1x DB-37F

### **Screw Terminal Panels**

DNA-STP-37: Standard 37-pin screw terminal panel, suitable for

use with all 37-pin I/O boards and cables.

DNA-STP-62: Standard 62-pin screw terminal panel, suitable for

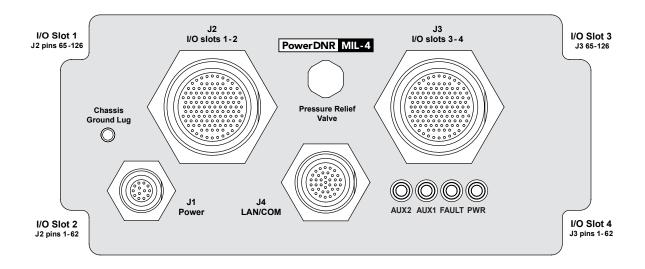
use with all 62-pin I/O boards and cables.

DNA-STP-3762: Standard 37-pin screw terminal panel, providing both

37- and 62-pin connectors and suitable for use with

any combination of I/O board.

## **Front Panel Layout**



# **38999 Connector Pinouts**

**128-pin I/O** — mating connector required: D38999/26FJ35PN



Pin #	I/O slot	Board Pin
1	2/4	1
2	2/4	2
3	2/4	3
4	2/4	4
5	2/4	5
6	2/4	6
7	2/4	7
8	2/4	8
9	2/4	9
10	2/4	10
11	2/4	11
12	2/4	12
13	2/4	13
14	2/4	14
15	2/4	15
16	2/4	16
17	2/4	17
18	2/4	18
19	2/4	19
20	2/4	20
21	2/4	21
22	2/4	22

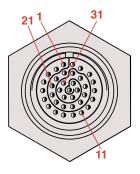
Pin#	I/O slot	Board Pin
23	2/4	23
24	2/4	24
25	2/4	25
26	2/4	26
27	2/4	27
28	2/4	28
29	2/4	29
30	2/4	30
31	2/4	31
32	2/4	32
33	2/4	33
34	2/4	34
35	2/4	35
36	2/4	36
37	2/4	37
38*	2/4	38
39	2/4	39
40	2/4	40
41	2/4	41
42	2/4	42
43	2/4	43
44	2/4	44
45	2/4	45

Pin #	I/O slot	Board Pin
46	2/4	46
47	2/4	47
48	2/4	48
49	2/4	49
50	2/4	50
51	2/4	51
52	2/4	52
53	2/4	53
54	2/4	54
55	2/4	55
56	2/4	56
57	2/4	57
58	2/4	58
59	2/4	59
60	2/4	60
61	2/4	61
62	2/4	62
63	n/a	n/a
64	n/a	n/a
65	1/3	1 1
66	1/3	2
67	1/3	3
68	1/3	4
69	1/3	5
70	1/3	6
71	1/3	7
72	1/3	8
73	1/3	9
74	1/3	10
75	1/3	11
76	1/3	12
77	1/3	13
78	1/3	14
79	1/3	15
80	1/3	16
81	1/3	17
82	1/3	18
83	1/3	19
84	1/3	20
85	1/3	21
86	1/3	22
00	1/3	

Pin#	I/O slot	Board Pin
87	1/3	23
88	1/3	24
89	1/3	25
90	1/3	26
91	1/3	27
92	1/3	28
93	1/3	29
94	1/3	30
95	1/3	31
96	1/3	32
97	1/3	33
98	1/3	34
99	1/3	35
100	1/3	36
101	1/3	37
102	1/3	38
103	1/3	39
104	1/3	40
105	1/3	41
106	1/3	42
107	1/3	43
108	1/3	44
109	1/3	45
110	1/3	46
111	1/3	47
112	1/3	48
113	1/3	49
114	1/3	50
115	1/3	51
116	1/3	52
117	1/3	53
118	1/3	54
119	1/3	55
120	1/3	56
121	1/3	57
122	1/3	58
123	1/3	59
124	1/3	60
125	1/3	61
126	1/3	62
127	-	n/a

\*Pins 38-62 are not applicable if I/O slot 1 contains a 37-pin board

### **37-pin LAN / COM port**—mating connector required: D38999/26WD35PN



Pin number	Pin designation
1	LAN0 TX+ / DA+
2	LAN0 RX+ / DB+
3	LAN0 nc / DC-
4	LAN0 nc / DD+
5	Shield
6	Lan1 TX+ / DA+
7	LAN1 RX+ / DB+
8	LAN1 nc / DC-
9	LAN1 nc / DD+
10	Shield
11	Misc In
12	USB1 P+
13	USB1 D+

Pin number	Pin designation
14	USB2 P+
15	USB2 P-
16	USB2 D+
17	USB2 D-
18	LAN0 TX- / DA-
19	LAN0 nc / DC+
20	LAN0 RX- / DB-
21	LAN0 nc / DD-
22	LAN1 TX- / DA-
23	LAN1 nc / DC+
24	LAN1 RX- / DB-
25	LAN1 nc / DD-
26	Misc Out

Pin number	Pin designation
27	USB1 P-
28	USB1 D-
29	Sync Clock Out
30	Sync Trig Out
31	RS232 TX
32	RS232 RX
33	RS232 GND
34	Sync Clock In
35	Sync Trig In
36	Sync +5V
37	Sync Gnd

**13-pin power connector**— mating connector required: D38999/26FB35PN



Pin #	Pin Designation
1	GND
2	GND
3	GND
4	Vcc (9-36 VDC)
5	Vcc (9-36 VDC)
6	Vcc (9-36 VDC)
7	Sync In2 / reset
8	Sync In0
9	Sync In1
10	Sync Gnd
11	Sync Out1
12	Sync +5V
13	Sync Out0